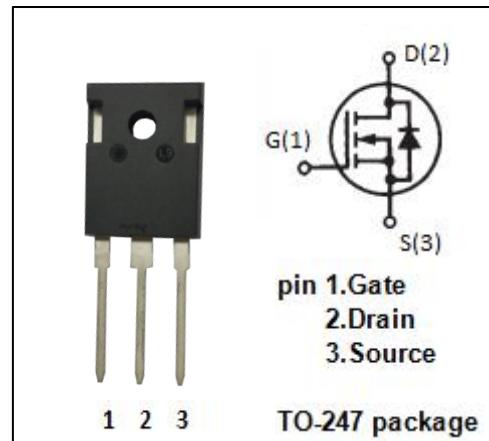


isc N-Channel MOSFET Transistor

STW13NK100Z

FEATURES

- Drain Current : $I_D = 12A$ @ $T_c=25^\circ\text{C}$
- Drain Source Voltage : $V_{DSS} = 1000V$ (Min)
- Static Drain-Source On-Resistance : $R_{DS(on)} = 1.0 \Omega$ (Max) @ $V_{GS} = 10V$
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation



DESCRIPTION

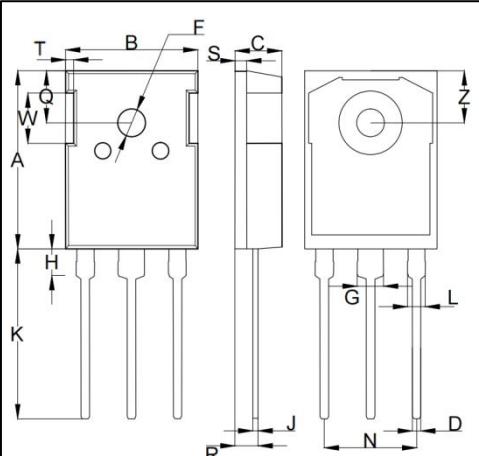
- motor drive, DC-DC converter, power switch and solenoid drive.

• ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ\text{C}$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	1000	V
V_{GS}	Gate-Source Voltage	± 30	V
I_D	Drain Current-Continuous;@ $T_c=25^\circ\text{C}$	12	A
I_{DM}	Drain Current-Single Pulsed	48	A
P_D	Total Dissipation	463	W
T_j	Operating Junction Temperature	-55~150	$^\circ\text{C}$
T_{stg}	Storage Temperature	-55~150	$^\circ\text{C}$

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th(ch-c)}$	Channel-to-case thermal resistance	0.25	$^\circ\text{C}/\text{W}$



DIM	mm	
	MIN	MAX
A	19.80	21.50
B	15.40	15.90
C	4.70	5.30
D	0.90	1.26
F	3.50	3.90
G	2.70	3.30
H	3.90	4.10
J	0.500	0.700
K	19.50	20.50
L	1.90	2.20
N	10.80	11.00
Q	6.00	6.30
R	2.90	3.30
S	1.80	2.20
T	2.15	2.35
W	4.90	5.10
Z	6.00	6.30

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ELECTRICAL CHARACTERISTICS

T_c=25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V; I _D = 0.25mA	1000			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} ; I _D = 0.25mA	2.5		4.5	V
R _{DSON}	Drain-Source On-Resistance	V _{GS} = 10V; I _D = 6A			1.0	Ω
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±30V; V _{DS} = 0V			±100	nA
I _{DSS}	Drain-Source Leakage Current	V _{DS} = 1000V; V _{GS} = 0V			1.0	uA
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz	-	3750	-	pF
C _{oss}	Output Capacitance		-	240	-	
C _{rss}	Reverse Transfer Capacitance		-	30	-	
Q _g	Total Gate Charge	V _{DD} = 500V, I _D = 12A, V _{GS} = 10V	-	73	-	nC
Q _{gs}	Gate-Source Charge		-	16	-	
Q _{gd}	Gate-Drain Charge		-	27	-	
t _{d(on)}	Turn-on Delay Time	V _{DD} = 500V, I _D = 12A, R _G = 9.1Ω , V _{GS} = 10V	-	35	-	ns
t _r	Turn-on Rise Time		-	36	-	
t _{d(off)}	Turn-off Delay Time		-	44	-	
t _f	Turn-off Fall Time		-	35	-	

Drain - Source Body Diode Characteristics

I _{SD}	Continuous Source Current	T _c = 25 °C	-	-	12	A
I _{SM}	Pulsed Source Current		-	-	48	
V _{SD}	Diode Forward Voltage	I _{SD} = 12A; V _{GS} = 0V	-	-	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _s = 12A, di/dt = 100A /μs	-	-	850	ns
Q _{rr}	Reverse Recovery Charge		-	-	4.4	

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